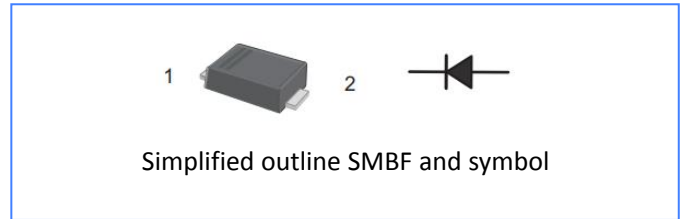


## RS2ABF THRU RS2MBF

### Features

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- Fast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives



Simplified outline SMBF and symbol

### Mechanical Data

- Case: SMBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 57mg / 0.002oz

### Pinning

PIN	DESCRIPTION
1	Cathode
2	Anode

### Absolute Maximum Ratings And Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	RS2ABF	RS2BBF	RS2DBF	RS2GBF	RS2JBF	RS2KBF	RS2MBF	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $T_c = 125^\circ\text{C}$	$I_{F(AV)}$	2							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	$I_{FSM}$	50							A
Maximum Forward Voltage at 1 A	$V_F$	1.3							V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Blocking Voltage $T_a = 125^\circ\text{C}$	$I_R$	5 100							$\mu\text{A}$
Typical Junction Capacitance at $V_R=4\text{V}$ $f=1\text{M}$	$C_j$	28							pF
Maximum Reverse Recovery Time <sup>(1)</sup>	$t_{rr}$	150				250	500		ns
Typical Thermal Resistance <sup>(2)</sup>	$R_{\theta JA}$	60							$^\circ\text{C}/\text{W}$
	$R_{\theta JC}$	18							
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150							$^\circ\text{C}$

(1) Measured with  $I_F = 0.5\text{A}$ ,  $I_R = 1\text{A}$ ,  $I_{rr} = 0.25\text{A}$

(2) .P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Rating And Characteristic Curves

Fig.1 Forward Current Derating Curve

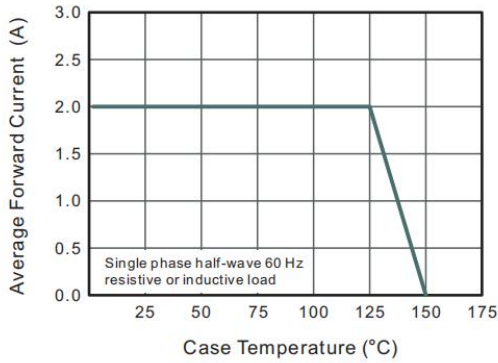


Fig.2 Typical Reverse Characteristics

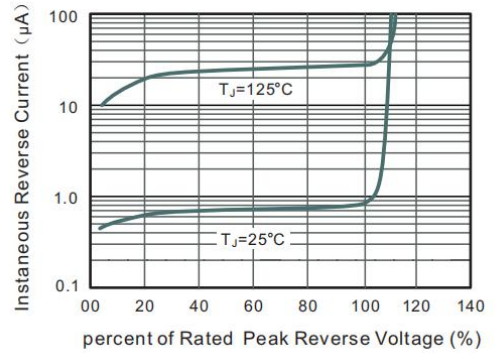


Fig.3 Typical Instantaneous Forward Characteristics

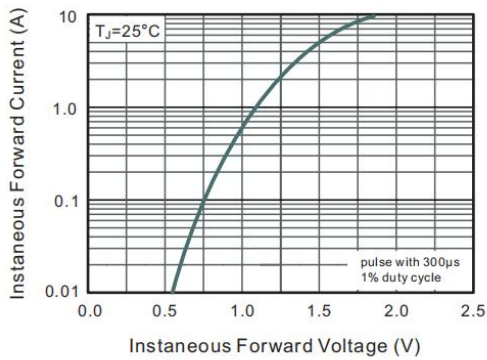


Fig.4 Typical Junction Capacitance

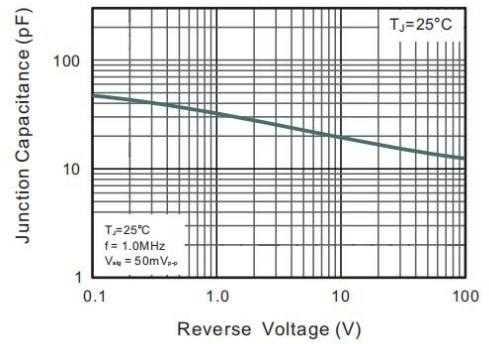
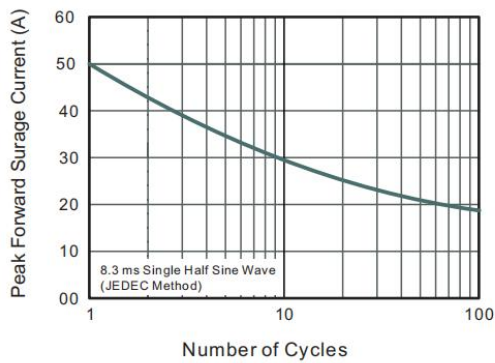


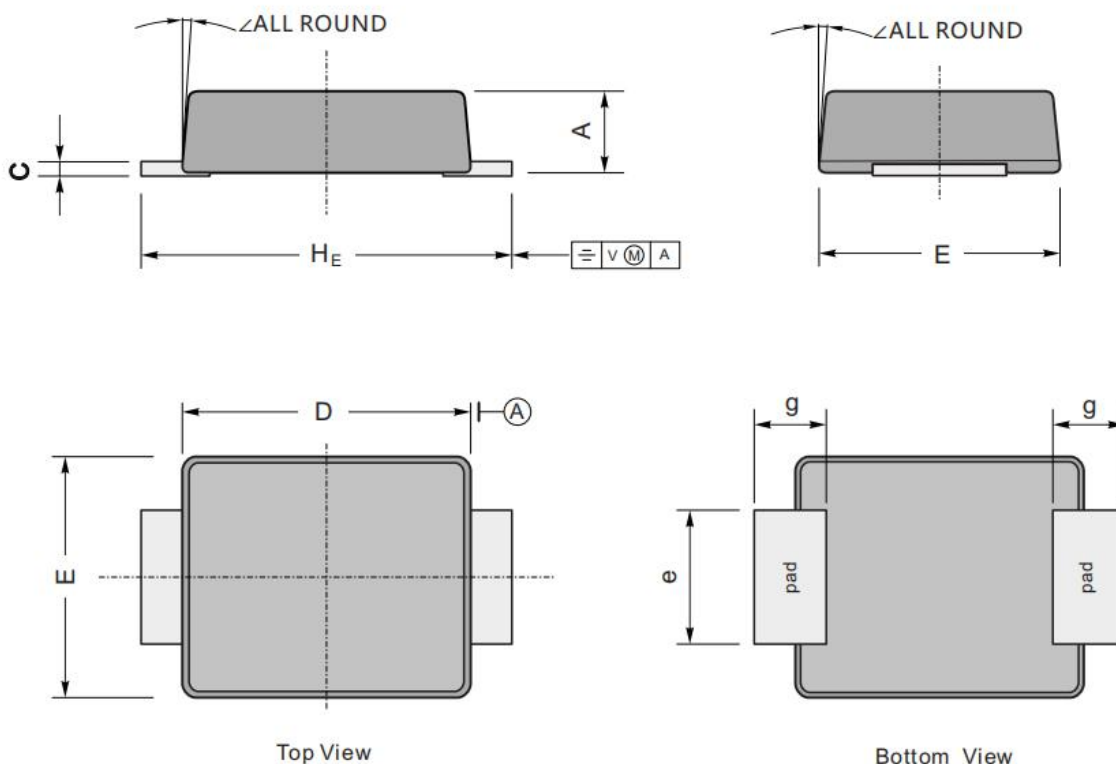
Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



Package Outline

Plastic surface mounted package; 2 leads

SMBF



UNIT		A	C	D	E	e	$H_E$	g	$\angle$
mm	max	1.3	0.26	4.4	3.7	2.2	5.5	1.0	9°
	min	1.1	0.18	4.2	3.5	1.9	5.1		
mil	max	51	10	173	146	86	216	40	
	min	43	7	165	138	75	200		

The recommended mounting pad size

